

TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (L²-π-MOSV)

2SJ525

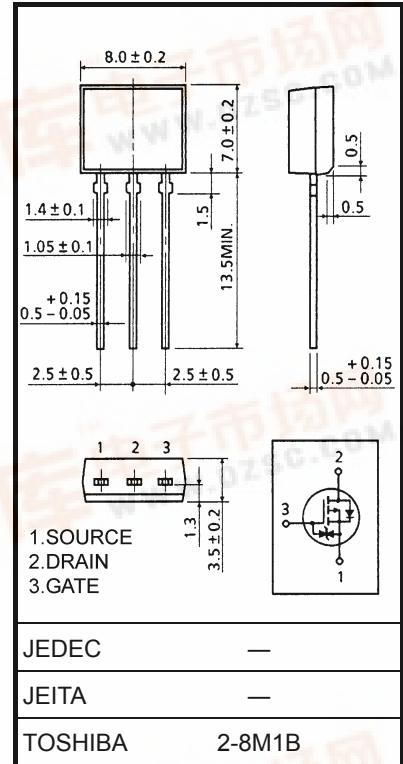
Chopper Regulator, DC-DC Converter and Motor Drive Applications

Unit: mm

- 4-V gate drive
- Low drain-source ON resistance : R_{DS(ON)} = 0.1 Ω (typ.)
- High forward transfer admittance : |Y_{fs}| = 4.5 S (typ.)
- Low leakage current : I_{DSS} = -100 μA (max) (V_{DS} = -30 V)
- Enhancement mode : V_{th} = -0.8~-2.0 V (V_{DS} = -10 V, I_D = -1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Drain-source voltage	V _{DSS}	-30	V
Drain-gate voltage (R _{GS} = 20 kΩ)	V _{DGR}	-30	V
Gate-source voltage	V _{GSS}	±20	V
Drain current	DC (Note 1)	I _D	-5 A
	Pulse (Note 1)	I _{DP}	-20 A
Drain power dissipation (Ta = 25°C)	P _D	1.3	W
Single pulse avalanche energy (Note 2)	E _{AS}	517	mJ
Avalanche current	I _{AR}	-5	A
Repetitive avalanche energy (Note 3)	E _{AR}	0.13	mJ
Channel temperature	T _{ch}	150	°C
Storage temperature range	T _{stg}	-55~150	°C



Weight: 0.54 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient	R _{th(ch-a)}	96.1	°C / W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = -25 V, T_{ch} = 25°C (initial), L = 14.84 mH, R_G = 25 Ω, I_D = -5 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.



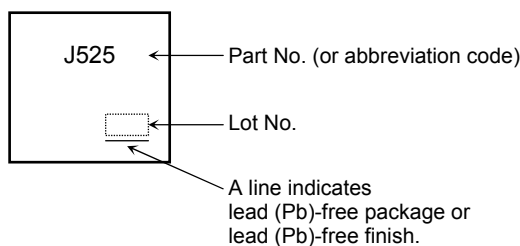
Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		I_{GSS}	$V_{GS} = \pm 16\text{ V}, V_{DS} = 0\text{ V}$	—	—	± 10	μA
Drain cut-off current		I_{DSS}	$V_{DS} = -30\text{ V}, V_{GS} = 0\text{ V}$	—	—	-100	μA
Drain-source breakdown voltage		$V_{(BR)DSS}$	$I_D = -10\text{ mA}, V_{GS} = 0\text{ V}$	-30	—	—	V
Gate threshold voltage		V_{th}	$V_{DS} = -10\text{ V}, I_D = -1\text{ mA}$	-0.8	—	-2.0	V
Drain-source ON resistance		$R_{DS(ON)}$	$V_{GS} = -4\text{ V}, I_D = -2.5\text{ A}$	—	0.17	0.2	Ω
			$V_{GS} = -10\text{ V}, I_D = -2.5\text{ A}$	—	0.1	0.12	
Forward transfer admittance		$ Y_{fs} $	$V_{DS} = -10\text{ V}, I_D = -2.5\text{ A}$	2.0	4.5	—	S
Input capacitance		C_{iss}	$V_{DS} = -10\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	—	850	—	pF
Reverse transfer capacitance		C_{rss}		—	250	—	
Output capacitance		C_{oss}		—	330	—	
Switching time	Rise time	t_r		—	50	—	ns
	Turn-on time	t_{on}		—	75	—	
	Fall time	t_f		—	20	—	
	Turn-off time	t_{off}		—	95	—	
Total gate charge (Gate-source plus gate-drain)		Q_g	$V_{DD} \approx -24\text{ V}, V_{GS} = -10\text{ V}, I_D = -5\text{ A}$	—	27	—	nC
Gate-source charge		Q_{gs}		—	19	—	
Gate-drain ("miller") charge		Q_{gd}		—	8	—	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	I_{DR}	—	—	—	-5	A
Pulse drain reverse current (Note 1)	I_{DRP}	—	—	—	-20	A
Forward voltage (diode)	V_{DSF}	$I_{DR} = -5\text{ A}, V_{GS} = 0\text{ V}$	—	—	1.7	V
Reverse recovery time	t_{rr}	$I_{DR} = -5\text{ A}, V_{GS} = 0\text{ V}$	—	60	—	ns
Reverse recovery charge	Q_{rr}	$dI_{DR} / dt = 50\text{ A} / \mu\text{s}$	—	56	—	nC

Marking



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